

**4626.0485 4-101.18 SOLDER AND FLUX; USE LIMITATION.**

Solder and flux containing lead in excess of 0.2 percent shall not be used on surfaces that contact food.

**Statutory Authority:** *MS s 31.101; 31.11; 144.05; 144.08; 144.12; 157.011*

**History:** *23 SR 519*

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